

HIGH BARRIER CAST MDO-PP POUCH

MDO-PP print film laminate with boosted EVOH barrier



Why high barrier Cast MDO-PP pouch?

Todays market challenge in cast film is to coextrude thin films with high barrier properties, excellent optics and non-polyoefinic content below 5% in one single production step. Our newly developed High Barrier Cast MDO-PP Pouch demonstrates how modern packaging solutions can combine high barrier and design for recycling.

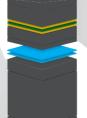
The pouch is based on two polypropylene films produced on our FILMEX" cast film line. By using a minimized amount of EVOH and applying MDO stretching, we significantly enhance the barrier performance – ideal for long shelf-life packaging applications. At the same time, we meet recyclability requirements: The non-polyolefin content remains significantly below 5% in the laminate. The result: a packaging structure with excellent clarity, enabling attractive product presentation despite the presence of EVOH.

Your advantages

- Superior Barrier Performance: MDOenhanced structure with minimum EVOH content enables OTR <1
- Tailored mechanical strength, low residual shrinkage
- Outstanding heat-resistance supports highspeed converting in pouch production
- W&H process and recipe know-how for optimized film transparency and product display

Sealing film

	Resins	Thickness	Functions
PP	Block and Random PP's	10.5 μm	Adhesive lamination, Mechanical Properties
PP	Block CoPP	49 µm	Mechanical Properties Body
PP	Random PP	10.5 μm	Sealing
Flextra 1			
	PP PP	PP Random PP's PP Block CoPP PP Random PP Flextra Type High Per	PP Random PP's 10.5 μm PP Block CoPP 49 μm PP Random PP 10.5 μm Total 70 μm



MDO print film with EVOH

	Amount	Resins		Layer Thickness	Functions
	100%	PP	High Christalline HomoPP	22.5 μm	Thermal resistance
·	100%	PP	Block CoPP	37.5 μm	Mechanical Properties
	100%	TIE	Admer type	11.7 µm	Bonding
	100%	EVOH	Soarnol type	9 µm	Oxygen Barrier
	100%	TIE	Admer type	11.7 µm	Bonding
	100%	PP	Block CoPP	37.5 μm	Mechanical Properties
	100%	PP	Homo and Random CoPP	22.5 μm	Print, lamination and thermal resistance

Total 150 µm

The primary film thickness is 150 μm and stretched down 1:5 to a secondary film of 30 μm . EVOH-content in the full laminate <2 %

Our partners















